



## NM2312A

5A, 20V N-CHANNEL MOSFET

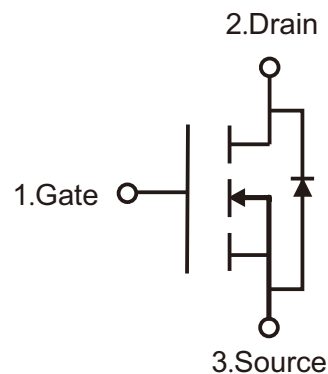
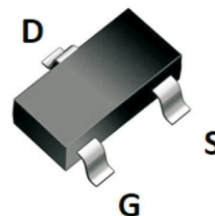
### Features

- $R_{DS(ON)} \leq 47m\Omega @ V_{GS}=2.5V$
- $R_{DS(ON)} \leq 41m\Omega @ V_{GS}=4.5V$
- Trench Power MV MOSFET technology
- High Density Cell Design for Low  $R_{DS(ON)}$
- High Speed switching

### Application

- Load Switch
- PWM Application
- Battery protection

SOT-23



### Absolute Maximum Ratings (TA=25°C, unless otherwise specified)

Parameter	Symbols	Ratings	Units
Drain-Source Voltage	$V_{DSS}$	20	V
Gate-Source Voltage	$V_{GSS}$	$\pm 8$	V
Continuous Drain Current	$I_D$	5.0	A
Pulsed Drain Current (Note1)	$I_{DM}$	20	A
Power Dissipation	$P_D$	1	W
Thermal Resistance, Junction to Ambient (Note2)	$R_{\theta JA}$	125	$^{\circ}C/W$
Operation Junction Temperature and Storage Temperature	$T_j, T_{stg}$	-55 ~ +150	$^{\circ}C$

Notes:

1. Pulse Test: Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$ .

2.  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design, while  $R_{\theta JA}$  is determined by the board design.

The maximum rating presented here is based on mounting on a 1 in 2 pad of 2oz copper.

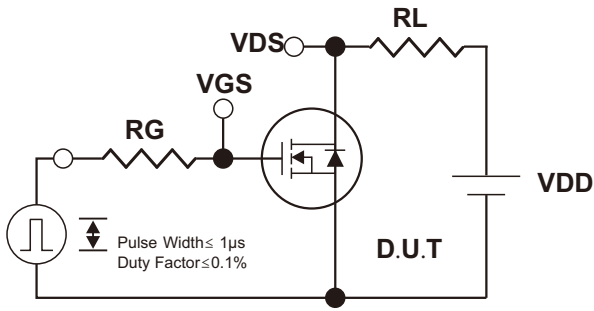


Electrical Characteristics (TA=25°C, unless otherwise specified)

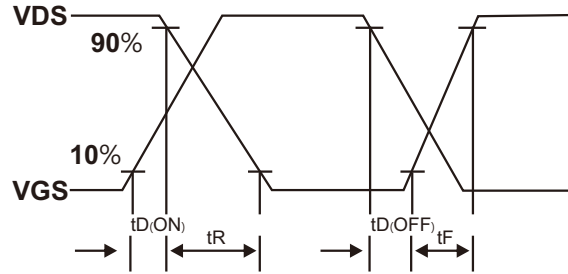
Parameter	Symbols	Test Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	20			V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=20V, V_{GS}=0V$			1	$\mu A$
Gate- Source Leakage Current	Forward	$V_{GS}=8V, V_{DS}=0V$			100	nA
	Reverse		$V_{GS}=-8V, V_{DS}=0V$			
<b>On Characteristics</b>						
Gate Threshold Voltage	$V_{th(GS)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.4	0.6	1.0	V
Static Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=2.5V, I_D=4.5A$		24	47	$m\Omega$
		$V_{GS}=4.5V, I_D=5.0A$		21	41	$m\Omega$
Drain-Source Diode Forward Voltage (Note 1)	$V_{SD}$	$I_S=1.7A, V_{GS}=0V$			1.4	V
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=10V,$ $V_{GS}=0V,$ $f=1.0MHz$		595		$\mu F$
Output Capacitance	$C_{oss}$			68		$\mu F$
Reverse Transfer Capacitance	$C_{rss}$			49		$\mu F$
<b>Switching Characteristics</b>						
Total Gate Charge	$Q_g$	$V_{DS}=10V, V_{GS}=4.5V,$ $I_D=5A$		11.16		nC
Gate-Source Charge	$Q_{gs}$			0.99		nC
Gate-Drain Charge	$Q_{gd}$			2.14		nC
Turn-On Delay Time	$t_{d(on)}$	$V_{DS}=10V, V_{GS}=4.5V$ $I_D=5A, R_{GEN}=3\Omega$		5		ns
Turn-On Rise Time	$t_r$			29		ns
Turn-Off Delay Time	$t_{d(off)}$			20		ns
Turn-Off Fall Time	$t_f$			2		ns



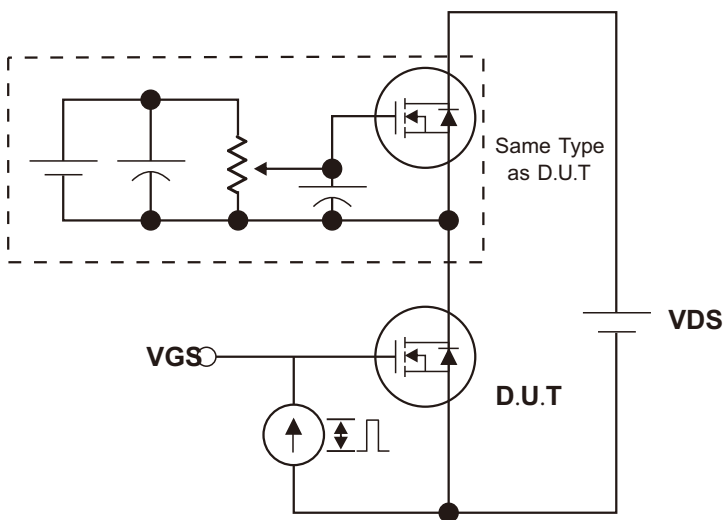
Test Circuits and waveforms



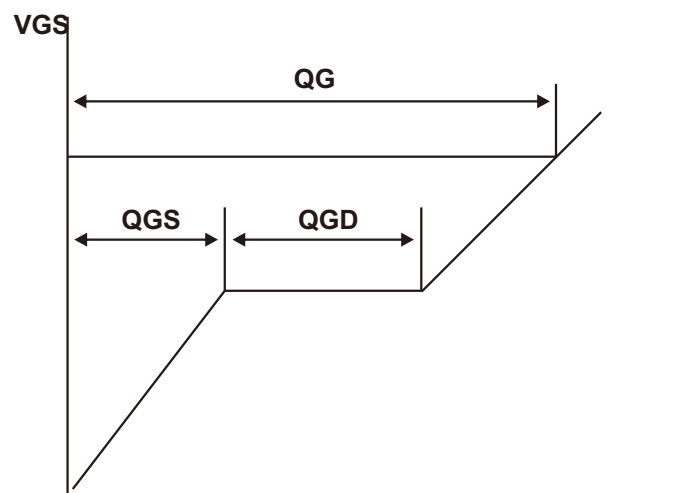
Switching Test Circuit



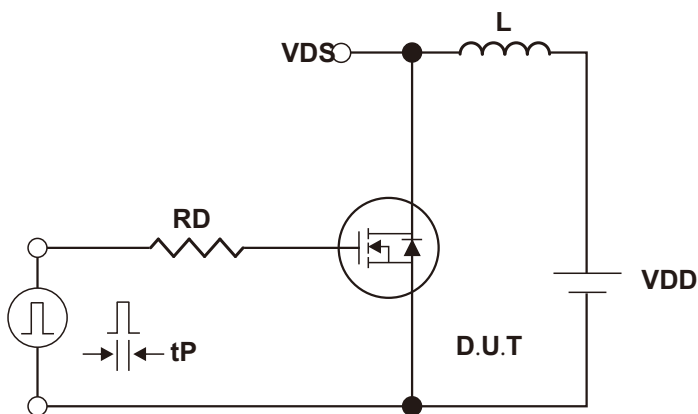
Switching Waveforms



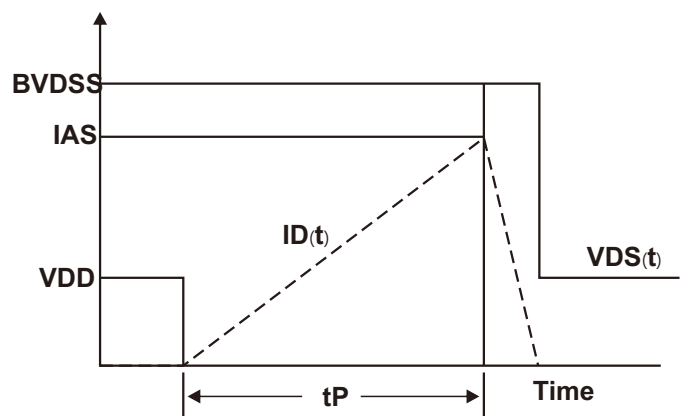
Gate Charge Test Circuit



Charge  
Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms



## Typical Characteristics

Fig.1 Output Characteristics

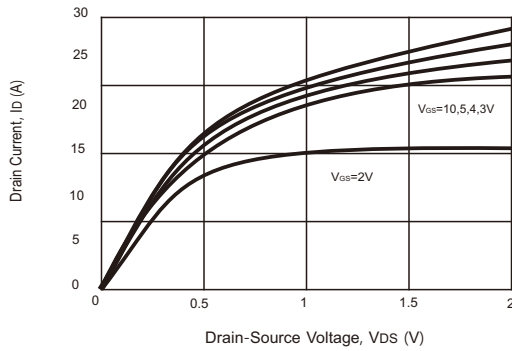


Fig.2 Typical Transfer Characteristics

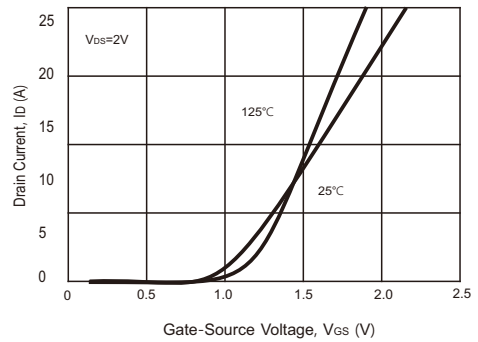


Fig.3 On-Resistance vs. Drain Current and Gate-Voltage

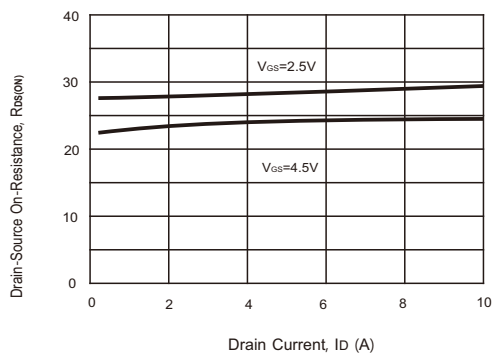


Fig.4 On-Resistance vs. Junction Temperature

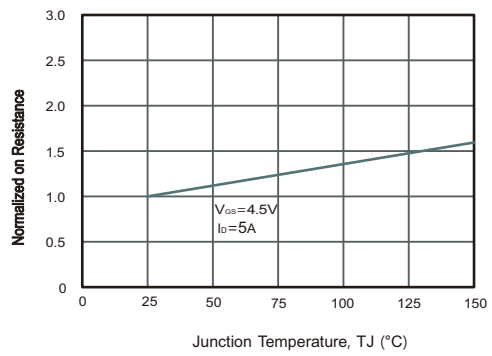
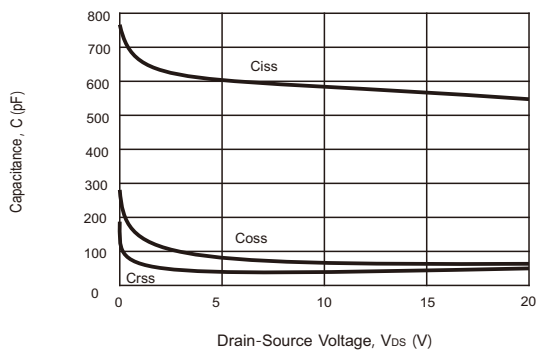
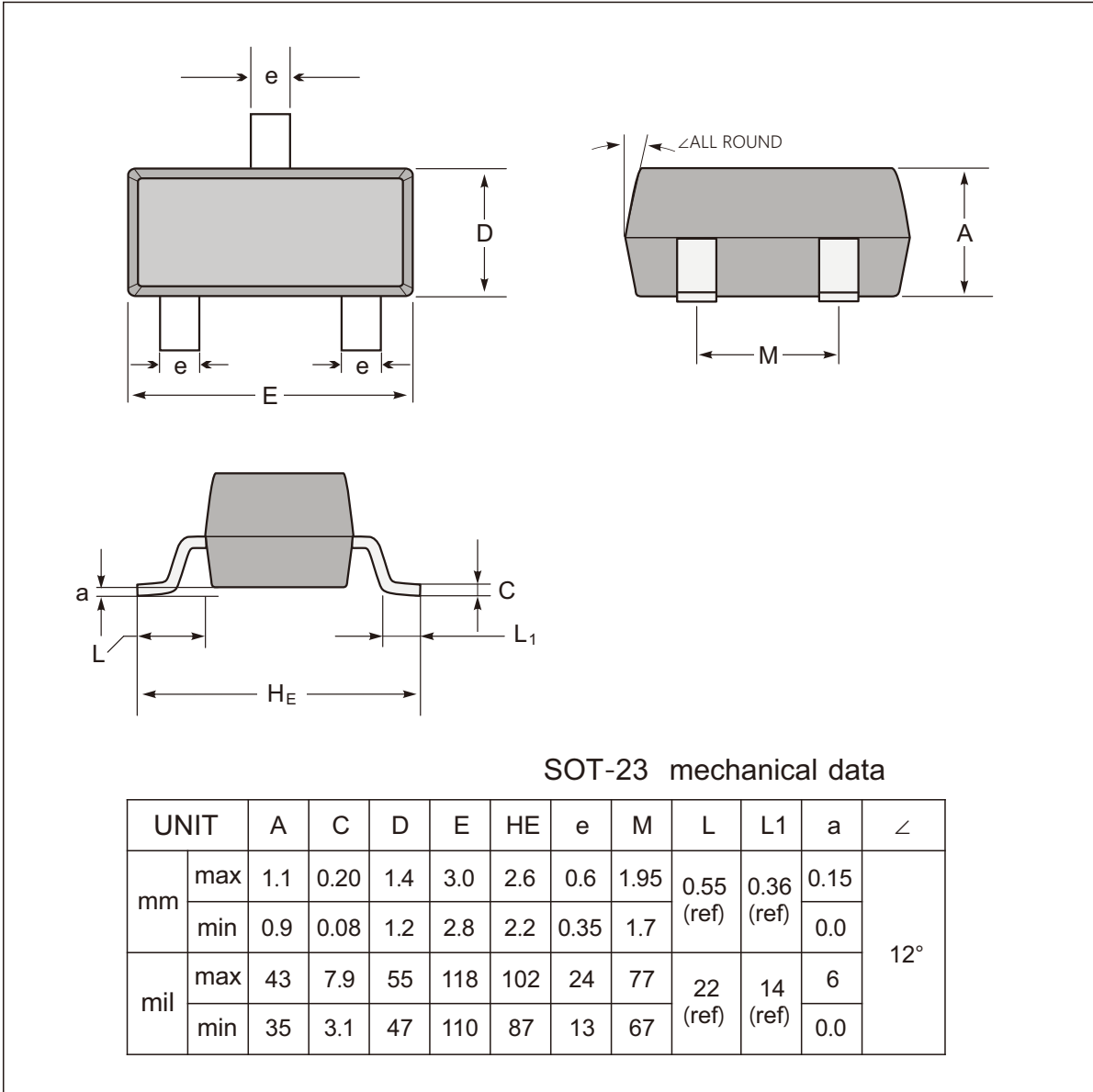


Fig.5 Capacitance Characteristics

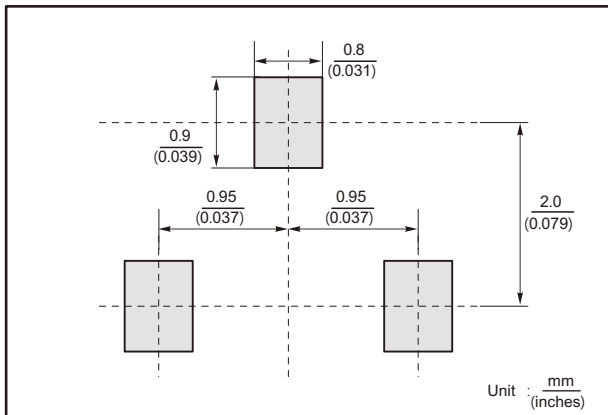




### SOT-23 Package Outline Dimensions



#### The recommended mounting pad size



#### Marking

Type number	Marking code
NM2312A	2312A



### Important Notice and Disclaimer

Jingdao Microelectronics reserves the right to make changes to this document and its products and specifications at any without notice.

Customers should obtain and confirm the latest product information and specifications before final, purchase or use.

Jingdao Microelectronics makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Jingdao Microelectronics assume any liability for application assistance or customer product design.

Jingdao Microelectronics does not warrant or accept any liability with products which are purchased or used for any unintended or unauthorized application.

No license is granted by implication or otherwise under any intellectual property rights of Jingdao Microelectronics.

Jingdao Microelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of Jingdao Microelectronics.